



# 5STF 09T1420

Old part no. TR 907C-850-14

## Fast Thyristor

### Properties

- § Amplifying gate
- § High operational capability
- § Optimized turn-off parameters

### Applications

- § Power switching applications

### Key Parameters

$V_{DRM}, V_{RRM}$	= 1 400	V
$I_{TAV}$	= 847	A
$I_{TSM}$	= 13.0	kA
$V_{TO}$	= 1.231	V
$r_T$	= 0.317	mΩ
$t_q$	= 20	μs

### Types

	$V_{RRM}, V_{DRM}$
5STF 09T1420..1425	1 400 V
5STF 09T1220..1225	1 200 V

Conditions:  
 $T = -40 \div 125$  °C, half sine waveform,  
 $f = 50$  Hz, note 1

### Mechanical Data

$F_m$	Mounting force	10 ± 2 kN
$m$	Weight	0.20 kg
$D_s$	Surface creepage distance	13 mm
$D_a$	Air strike distance	8 mm

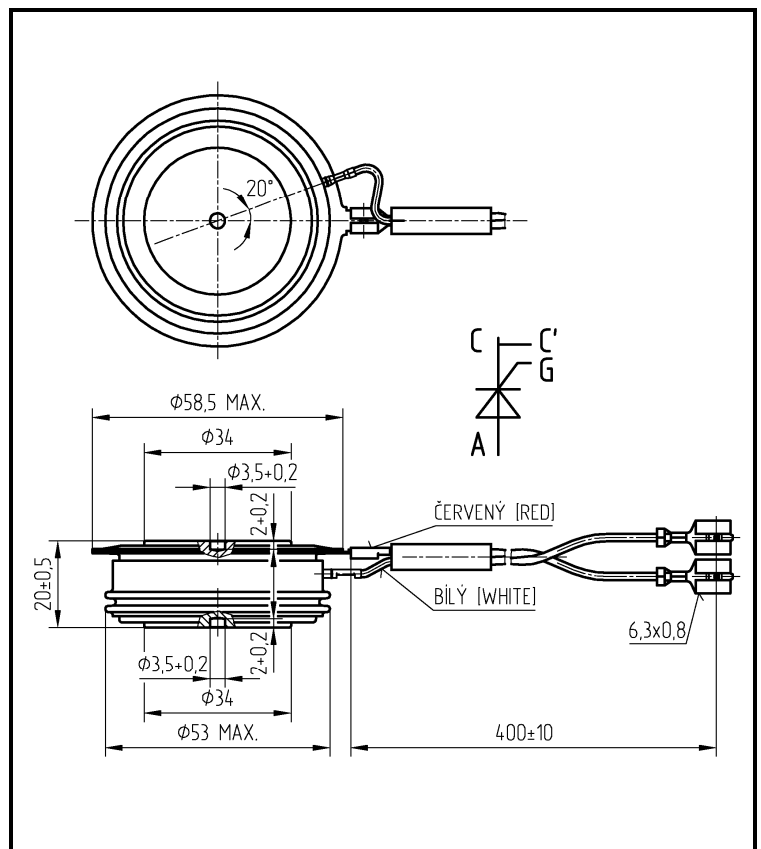


Fig. 1 Case



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<b>Maximum Ratings</b>			<b>Maximum Limits</b>	<b>Unit</b>
$V_{RRM}$ $V_{DRM}$	<b>Repetitive peak reverse and off-state voltage</b> $T_j = -40 \div 125 \text{ }^\circ\text{C}$ , note 1	5STF 09T1420..1425 5STF 09T1220..1225	1 400 V 1 200 V	V
$I_{TRMS}$	<b>RMS on-state current</b> $T_c = 70 \text{ }^\circ\text{C}$ , half sine waveform, $f = 50 \text{ Hz}$		1 330	A
$I_{TAVm}$	<b>Average on-state current</b> $T_c = 70 \text{ }^\circ\text{C}$ , half sine waveform, $f = 50 \text{ Hz}$		847	A
$I_{TSM}$	<b>Peak non-repetitive surge</b> half sine pulse, $V_R = 0 \text{ V}$	$t_p = 10 \text{ ms}$ $t_p = 8.3 \text{ ms}$	13 000 13 900	A
$\int i^2 t$	<b>Limiting load integral</b> half sine pulse, $V_R = 0 \text{ V}$	$t_p = 10 \text{ ms}$ $t_p = 8.3 \text{ ms}$	845 000 800 000	A <sup>2</sup> s
$(di_T/dt)_{cr}$	<b>Critical rate of rise of on-state current</b> $I_T = I_{TAVm}$ , half sine waveform, $f = 50 \text{ Hz}$ , $V_D = 2/3 V_{DRM}$ , $t_r = 0.3 \text{ } \mu\text{s}$ , $I_{GT} = 2 \text{ A}$		800	A/ $\mu\text{s}$
$(dv_D/dt)_{cr}$	<b>Critical rate of rise of off-state voltage</b> $V_D = 2/3 V_{DRM}$		1 000	V/ $\mu\text{s}$
$P_{GAVm}$	<b>Maximum average gate power losses</b>		3	W
$I_{FGM}$	<b>Peak gate current</b>		10	A
$V_{FGM}$	<b>Peak gate voltage</b>		12	V
$V_{RGM}$	<b>Reverse peak gate voltage</b>		10	V
$T_{jmin} - T_{jmax}$	<b>Operating temperature range</b>		-40 $\div$ 125	$^\circ\text{C}$
$T_{stgmin} - T_{stgmax}$	<b>Storage temperature range</b>		-40 $\div$ 125	$^\circ\text{C}$

Unless otherwise specified  $T_j = 125 \text{ }^\circ\text{C}$

Note 1: De-rating factor of 0.13%  $V_{RRM}$  or  $V_{DRM}$  per  $^\circ\text{C}$  is applicable for  $T_j$  below  $25 \text{ }^\circ\text{C}$

Characteristics		Value			Unit
		min.	typ.	max.	
$V_{TM}$	<b>Maximum peak on-state voltage</b> $I_{TM} = 1\ 500\ A$			1.710	V
$V_{T0}$	<b>Threshold voltage</b>			1.231	V
$r_T$	<b>Slope resistance</b> $I_{T1} = 1\ 335\ A, I_{T2} = 4\ 006\ A$			0.317	mW
$I_{DM}$	<b>Peak off-state current</b> $V_D = V_{DRM}$			70	mA
$I_{RM}$	<b>Peak reverse current</b> $V_R = V_{RRM}$			70	mA
$t_{gd}$	<b>Delay time</b> $T_j = 25\ ^\circ C, V_D = 0.4\ V_{DRM}, I_{TM} = I_{TAVM},$ $t_r = 0.3\ \mu s, I_{GT} = 2\ A$			2.0	$\mu s$
$t_{q1}$	<b>Turn-off time</b> $I_T = 500\ A, di_T/dt = -50\ A/\mu s,$ $V_R = 100\ V, V_D = 2/3\ V_{DRM},$ $dv_D/dt = 50\ V/\mu s$	<b>group of <math>t_q</math></b> <b>5STF 09T1420</b> <b>5STF 09T1220</b>  <b>5STF 09T1425</b> <b>5STF 09T1225</b>		20.0   25.0	$\mu s$
$Q_{rr}$	<b>Recovery charge</b> <i>the same conditions as at <math>t_{q1}</math></i>			380	$\mu C$
$I_{rrM}$	<b>Reverse recovery current</b> <i>the same conditions as at <math>t_{q1}</math></i>			140	A
$I_H$	<b>Holding current</b>	$T_j = 25\ ^\circ C$ $T_j = 125\ ^\circ C$		250 150	mA
$I_L$	<b>Latching current</b>	$T_j = 25\ ^\circ C$ $T_j = 125\ ^\circ C$		1 500 1 000	mA
$V_{GT}$	<b>Gate trigger voltage</b> $V_D = 12V, I_T = 4\ A$	$T_j = -40\ ^\circ C$ $T_j = 25\ ^\circ C$ $T_j = 125\ ^\circ C$	0.25	4 3 2	V
$I_{GT}$	<b>Gate trigger current</b> $V_D = 12V, I_T = 4\ A$	$T_j = -40\ ^\circ C$ $T_j = 25\ ^\circ C$ $T_j = 125\ ^\circ C$	10	1000 500 300	mA

Unless otherwise specified  $T_j = 125\ ^\circ C$

<b>Thermal Parameters</b>		<b>Value</b>	<b>Unit</b>
<b><math>R_{thjc}</math></b>	<b>Thermal resistance junction to case</b> <i>double side cooling</i>	<b>32.0</b>	<b>K/kW</b>
	<i>anode side cooling</i>	<b>52.0</b>	
	<i>cathode side cooling</i>	<b>83.0</b>	
<b><math>R_{thch}</math></b>	<b>Thermal resistance case to heatsink</b> <i>double side cooling</i>	<b>10.0</b>	<b>K/kW</b>
	<i>single side cooling</i>	<b>20.0</b>	

### Transient Thermal Impedance

Analytical function for transient thermal impedance

$$Z_{thjc} = \sum_{i=1}^5 R_i (1 - \exp(-t/\tau_i))$$

Conditions:

$F_m = 10 \pm 2$  kN, Double side cooled

Correction for periodic waveforms

180° sine:	add 2.3 K/kW
180° rectangular:	add 3.1 K/kW
120° rectangular:	add 5.2 K/kW
60° rectangular:	add 8.7 K/kW

$i$	1	2	3	4	5
$t_i$ (s)	0.4857	0.2162	0.0762	0.0043	0.0006
$R_i$ (K/kW)	13.07	8.03	8.20	2.57	0.13

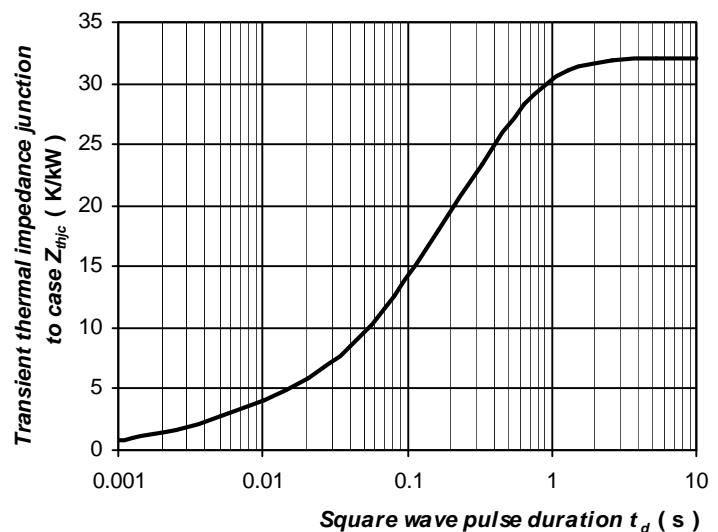


Fig. 2 Dependence transient thermal impedance junction to case on square pulse

### On-State Characteristics

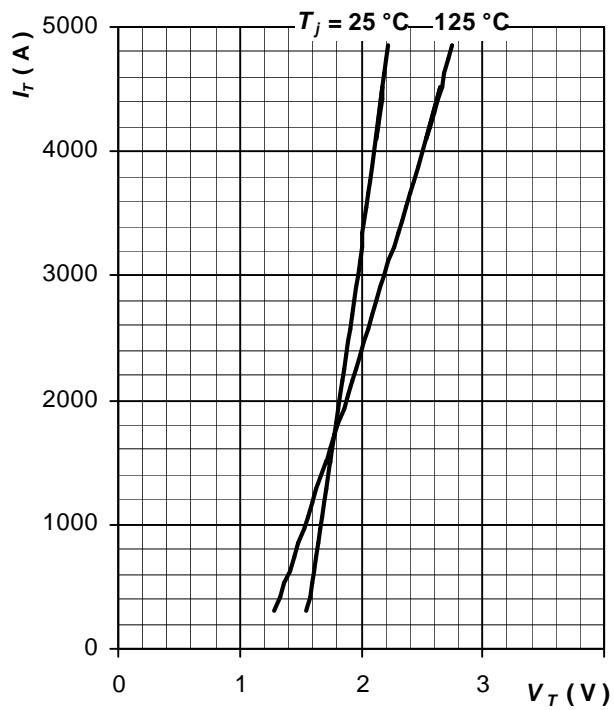


Fig. 3 Maximum on-state characteristics

### Gate Trigger Characteristics

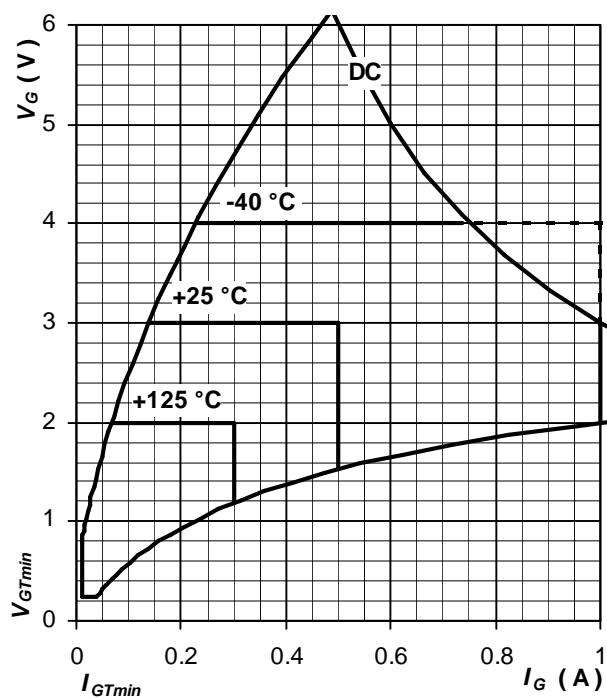


Fig. 4 Gate trigger characteristics

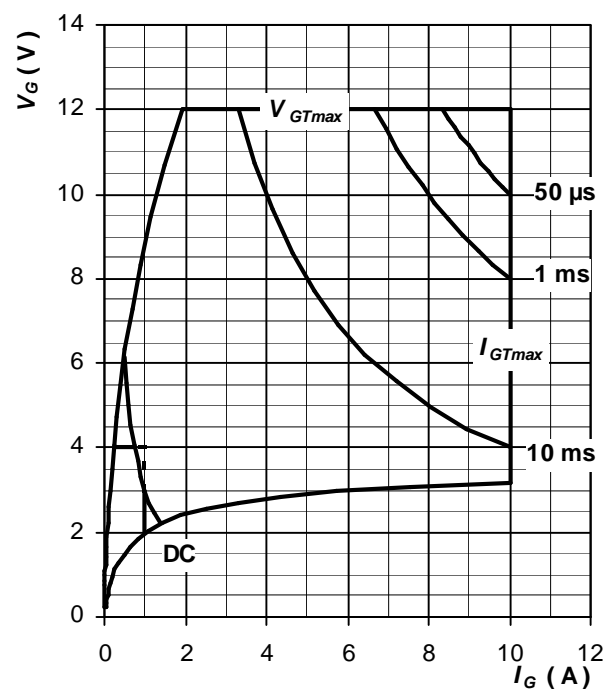


Fig. 5 Maximum peak gate power loss

## Surge Characteristics

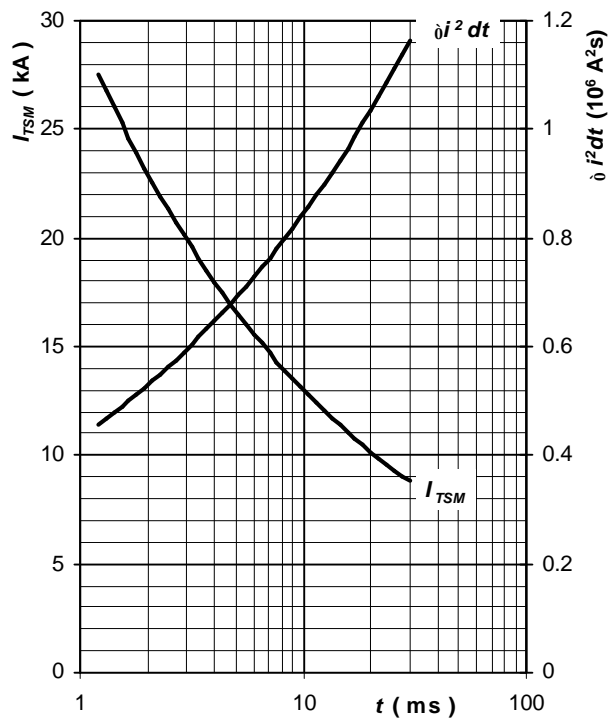


Fig. 6 Surge on-state current vs. pulse length, half sine wave, single pulse,  $V_R = 0 \text{ V}$ ,  $T_j = T_{jmax}$

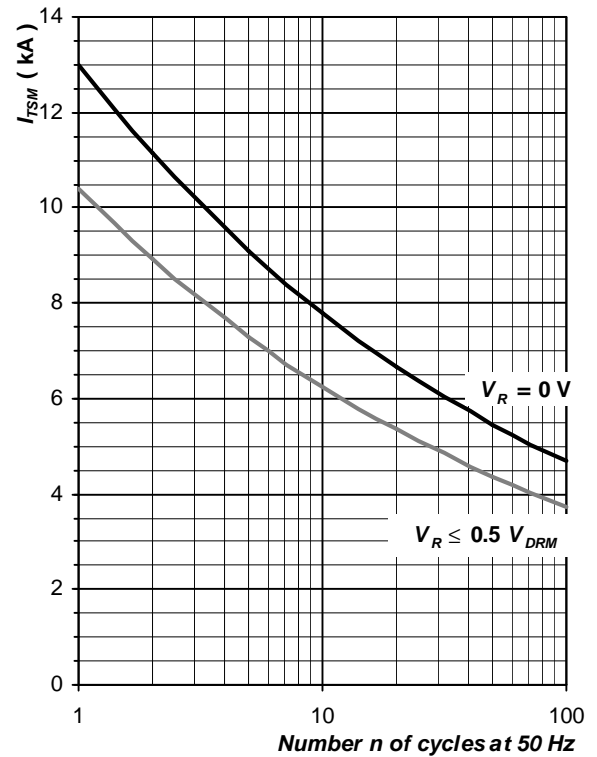


Fig. 7 Surge on-state current vs. number of pulses, half sine wave,  $T_j = T_{jmax}$

**Power Loss and Maximum Case Temperature Characteristics**

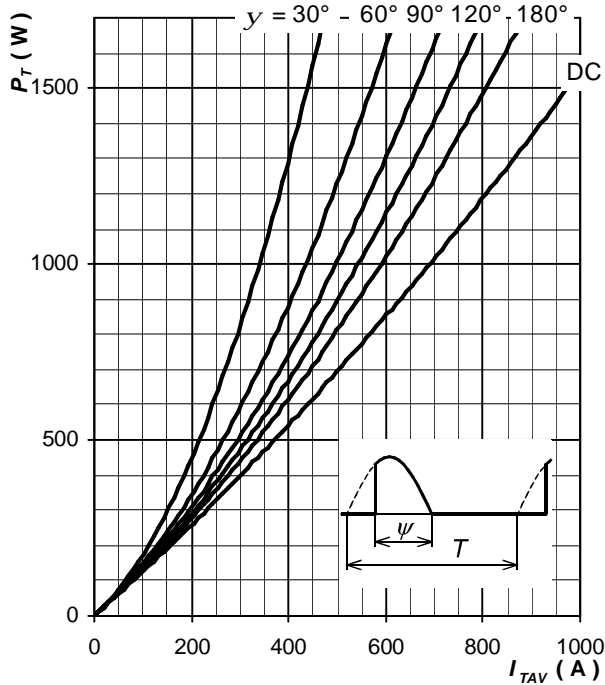


Fig. 8 On-state power loss vs. average on-state current, sine waveform,  $f = 50 \text{ Hz}$ ,  $T = 1/f$

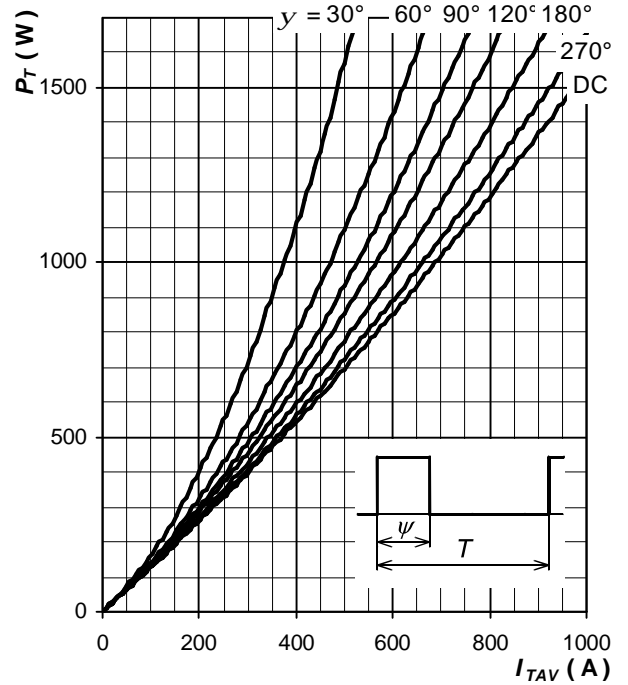


Fig. 9 On-state power loss vs. average on-state current, square waveform,  $f = 50 \text{ Hz}$ ,  $T = 1/f$

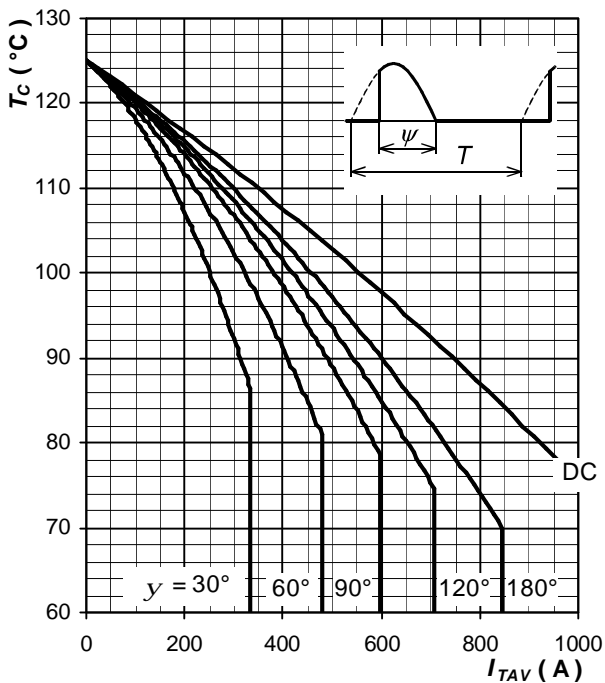


Fig. 10 Max. case temperature vs. aver. on-state current, sine waveform,  $f = 50 \text{ Hz}$ ,  $T = 1/f$

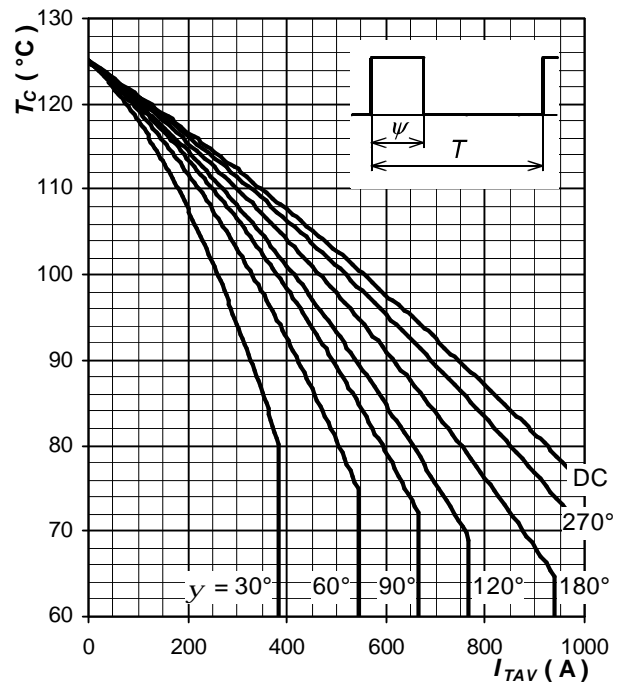


Fig. 11 Max. case temperature vs. aver. on-state current, square waveform,  $f = 50 \text{ Hz}$ ,  $T = 1/f$

Note 2: Figures number 8 , 11 have been calculated without considering any turn-on and turn-off losses. They are valid for  $f = 50$  or  $60 \text{ Hz}$  operation.

### Turn-off Time, Parameter Relationship

Maximum values of turn-off time at application specific conditions are given by using this formula:

$$t_q = t_{q1} \cdot \frac{t_q(T_j)}{t_{q1}} \cdot \frac{t_q(dv_D/dt)}{t_{q1}} \cdot \frac{t_q(-di_T/dt)}{t_{q1}}$$

where:

$t_{q1}$  is turn-off time at standard conditions, see section "Characteristics"

$\frac{t_q(T_j)}{t_{q1}}$  is factor to be taken from fig. 12

$\frac{t_q(dv_D/dt)}{t_{q1}}$  is factor to be taken from fig. 13

$\frac{t_q(-di_T/dt)}{t_{q1}}$  is factor to be taken from fig. 14

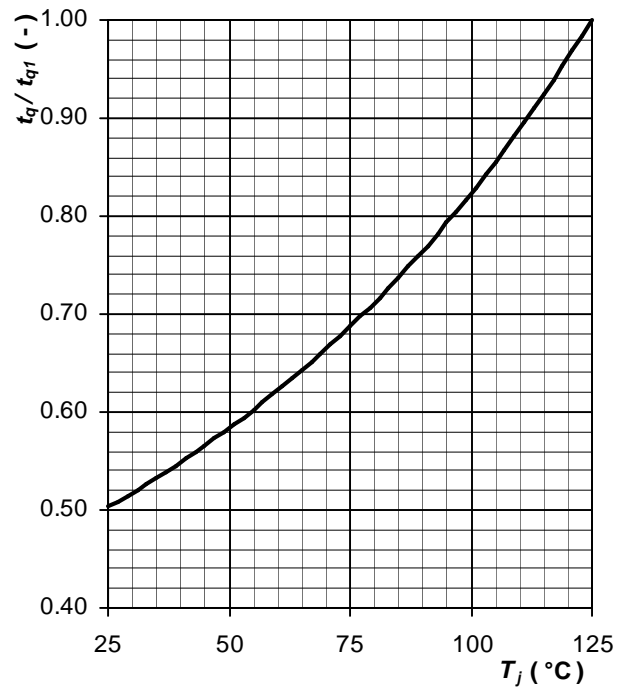


Fig. 12 Normalised maximum turn-off time vs. junction temperature

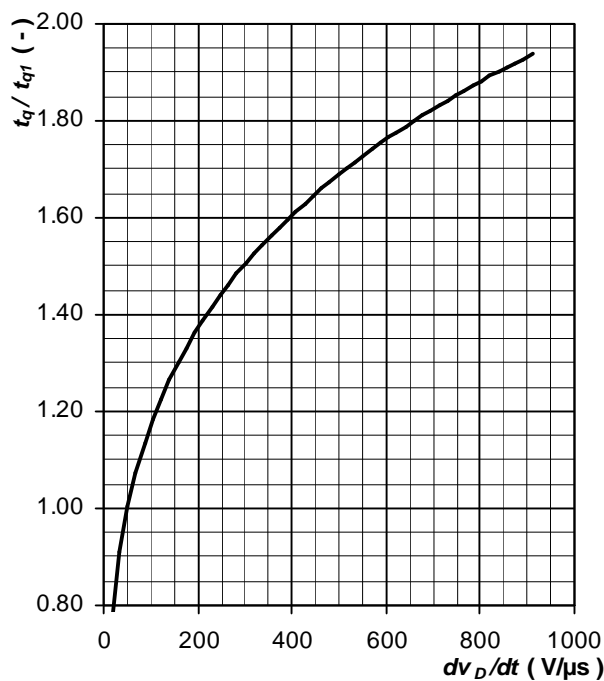


Fig. 13 Normalised maximum turn-off time vs. rate of rise of off-state voltage

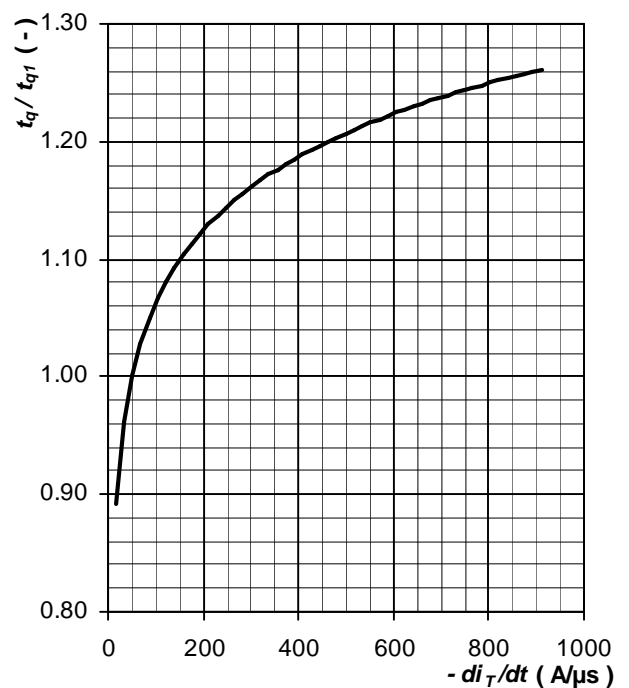


Fig. 14 Normalised maximum turn-off time vs. rate of fall of on-state current



## Turn-on Characteristics



Fig. 15 Typical waveforms and definition of symbols at turn-on of a thyristor

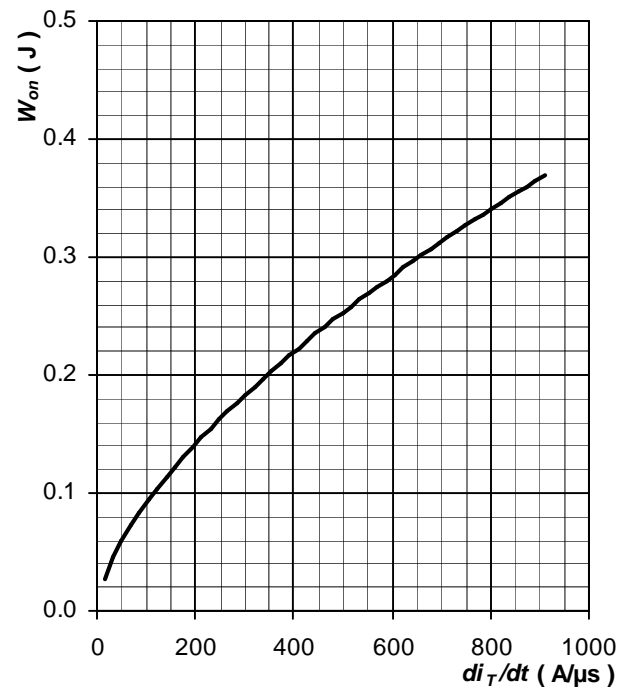


Fig. 16 Maximum turn-on energy per pulse vs. rate of rise on-state current,  $T_j = T_{jmax}$

**Turn-off Characteristics**

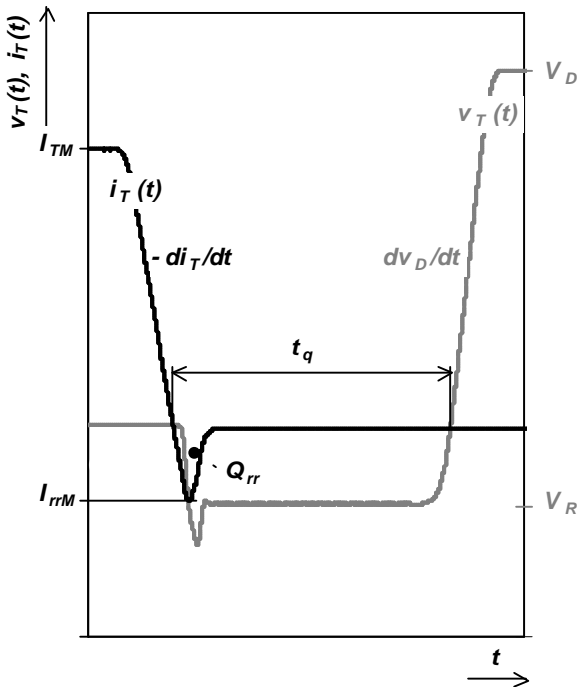


Fig. 17 Typical waveforms and definition of symbols at turn-off of a thyristor, inductive switching without RC snubber

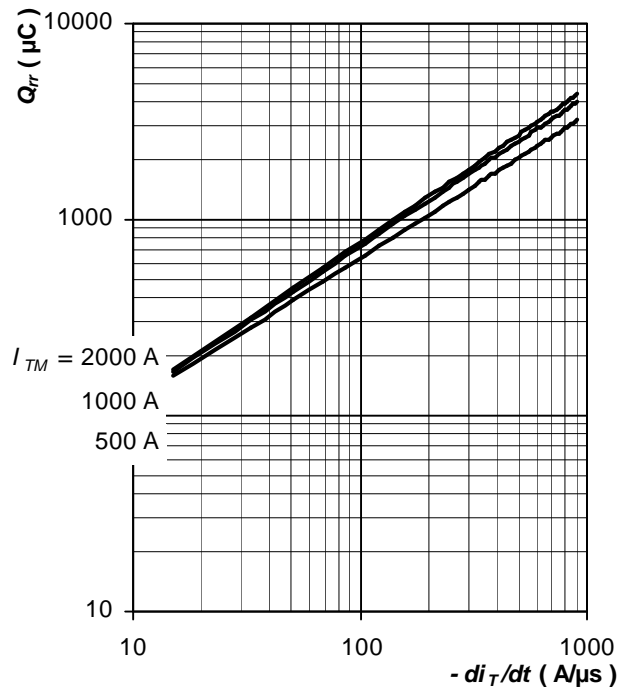


Fig. 18 Max. recovered charge vs. rate of fall on-state current, trapezoid pulse,  $V_R = 100 \text{ V}$ ,  $T_j = T_{jmax}$

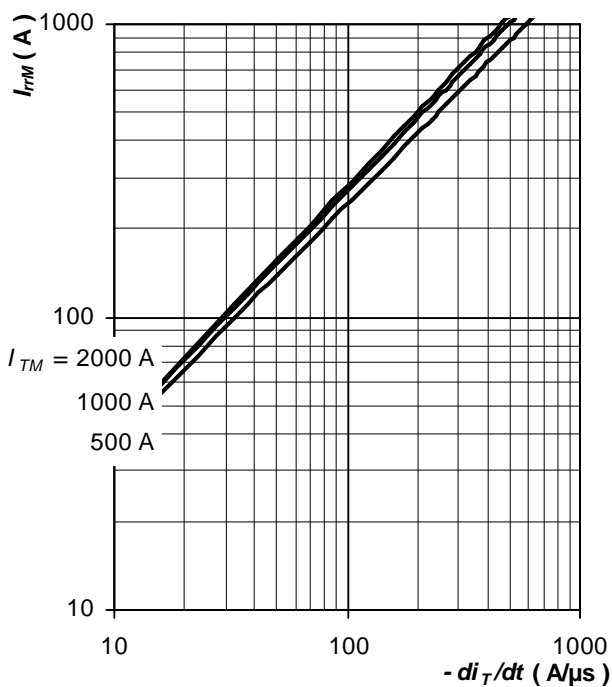


Fig. 19 Max. reverse recovery current vs. rate of fall on-state current, trapezoid pulse,  $V_R = 100 \text{ V}$ ,  $T_j = T_{jmax}$

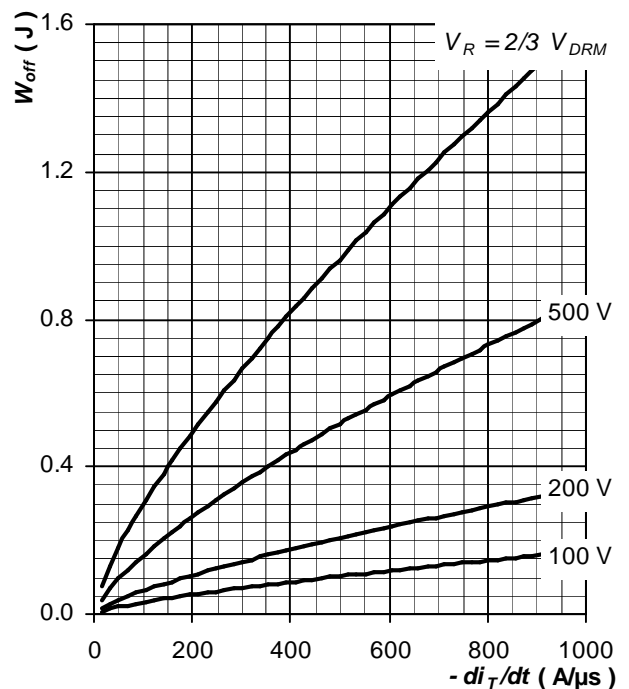


Fig. 20 Maximum turn-off energy per pulse vs. rate of fall on-state current, trapezoid pulse, inductive switching without RC snubber,  $I_{TM} = 2\ 000 \text{ A}$ ,  $T_j = T_{jmax}$

Notes:

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